Monolithic temperature and

overload protected logic level power MOSFET in **TOPFET2** technology assembled in a 3 pin plastic

General purpose switch for driving

TrenchMOS output stage

Overtemperature protection Protection latched reset by input

5 V logic compatible input level Control of output stage and supply of overload protection

circuits derived from input

Low operating input current

ESD protection on all pins

Overvoltage clamping for turn

permits direct drive by micro-controller

off of inductive loads

DESCRIPTION

**APPLICATIONS** 

package.

lamps

motors solenoids

heaters

**FEATURES** 

Current limiting Overload protection

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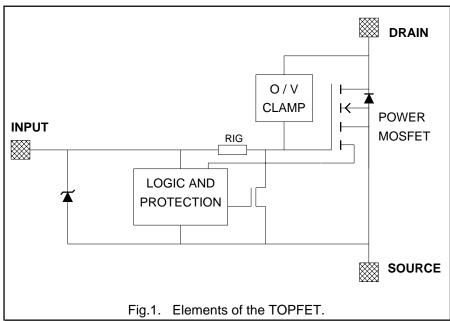
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### Logic level TOPFET

#### QUICK REFERENCE DATA

| SYMBOL                                      | PARAMETER   | MAX.                        | UNIT                    |
|---|---|-----------------------------|-------------------------|
| $V_{DS} \\ I_D \\ P_D \\ T_j \\ R_{DS(ON)}$ | Continuous drain source voltage<br>Continuous drain current<br>Total power dissipation<br>Continuous junction temperature<br>Drain-source on-state resistance | 50<br>20<br>90<br>150<br>28 | V<br>A<br>W<br>°C<br>mΩ |
| I <sub>ISL</sub>                            | Input supply current $V_{IS} = 5 V$   | 650                         | μA                      |

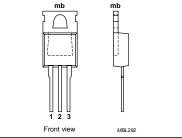
#### FUNCTIONAL BLOCK DIAGRAM



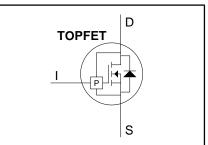
#### **PINNING - SOT78B**

| PIN | DESCRIPTION |
|-----|-------------|
| 1   | input       |
| 2   | drain       |
| 3   | source      |
| tab | drain       |

# PIN CONFIGURATION



#### SYMBOL



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#### LIMITING VALUES

Limiting values in accordance with the Absolute Maximum Rating System (IEC 134)

| SYMBOL           | PARAMETER                                    | CONDITIONS                                    | MIN. | MAX.    | UNIT |
|------------------|--|---|------|---------|------|
| V <sub>DS</sub>  | Continuous drain source voltage <sup>1</sup> |   | -    | 50      | V    |
| I <sub>D</sub>   | Continuous drain current                     | $V_{IS} = 5 V; T_{mb} = 25^{\circ}C$          | -    | self -  | А    |
|                  |  |   |      | limited |      |
| I <sub>D</sub>   | Continuous drain current                     | V <sub>IS</sub> = 5 V; T <sub>mb</sub> ≤121°C | -    | 20      | А    |
| I,               | Continuous input current                     |   | -5   | 5       | mA   |
| I <sub>IRM</sub> | Repetitive peak input current                | $δ \le 0.1$ , tp = 300 μs                     | -50  | 50      | mA   |
| P <sub>D</sub>   | Total power dissipation                      | $T_{mb} \le 25^{\circ}C$                      | -    | 90      | W    |
| T <sub>stg</sub> | Storage temperature                          |   | -55  | 175     | °C   |
| Tj               | Continuous junction temperature <sup>2</sup> | normal operation                              | -    | 150     | °C   |
| $T_{sold}$       | Lead temperature                             | during soldering                              | -    | 260     | °C   |

#### ESD LIMITING VALUE

| SYMBOL         | PARAMETER                                 | CONDITIONS  | MIN. | MAX. | UNIT |
|----------------|---|---|------|------|------|
| V <sub>c</sub> | Electrostatic discharge capacitor voltage | Human body model;<br>C = 250 pF; R = 1.5 k $\Omega$ | -    | 2    | kV   |

#### **OVERVOLTAGE CLAMPING LIMITING VALUES**

At a drain source voltage above 50 V the power MOSFET is actively turned on to clamp overvoltage transients.

| SYMBOL                               | PARAMETER   | CONDITIONS   | MIN. | MAX.      | UNIT     |
|--------------------------------------|---|--|------|-----------|----------|
| E <sub>DSM</sub><br>E <sub>DRM</sub> | Inductive load turn-off<br>Non-repetitive clamping energy<br>Repetitive clamping energy | $ \begin{split} I_{DM} &= 20 \text{ A};  V_{DD} \leq 20 \text{ V} \\ T_{mb} &\leq 25 ^\circ\text{C} \\ T_{mb} &\leq 95 ^\circ\text{C};  f = 250  \text{Hz} \end{split} $ | -    | 350<br>45 | mJ<br>mJ |

### **OVERLOAD PROTECTION LIMITING VALUE**

With an adequate protection supply provided via the input pin, TOPFET can protect itself from two types of overload - overtemperature and short circuit load.

| SYMBOL          | PARAMETER                         | REQUIRED CONDITION           | MIN. | MAX. | UNIT |  |
|-----------------|-----------------------------------|------------------------------|------|------|------|--|
| V <sub>DS</sub> | Drain source voltage <sup>3</sup> | $4~V \leq V_{IS} \leq 5.5~V$ | 0    | 35   | V    |  |

### THERMAL CHARACTERISTIC

| SYMBOL               | PARAMETER                 | CONDITIONS | MIN. | TYP. | MAX. | UNIT |
|----------------------|---------------------------|------------|------|------|------|------|
|                      | Thermal resistance        |            |      |      |      |      |
| R <sub>th j-mb</sub> | Junction to mounting base | -          | -    | 1.25 | 1.39 | K/W  |

<sup>1</sup> Prior to the onset of overvoltage clamping. For voltages above this value, safe operation is limited by the overvoltage clamping energy.

**<sup>2</sup>** A higher  $T_j$  is allowed as an overload condition but at the threshold  $T_{j(TO)}$  the over temperature trip operates to protect the switch.

<sup>3</sup> All control logic and protection functions are disabled during conduction of the source drain diode.

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### **OUTPUT CHARACTERISTICS**

Limits are for -40°C  $\leq$  T<sub>mb</sub>  $\leq$  150°C; typicals are for T<sub>mb</sub> = 25°C unless otherwise specified

| SYMBOL               | PARAMETER                     | CONDITIONS   | MIN. | TYP. | MAX. | UNIT |
|----------------------|-------------------------------|--|------|------|------|------|
|                      | Off-state                     | $V_{IS} = 0 V$   |      |      |      |      |
| V <sub>(CL)DSS</sub> | Drain-source clamping voltage | I <sub>D</sub> = 10 mA   | 50   | -    | -    | V    |
|                      |                               | $I_{\text{DM}}$ = 4 A; $t_{p} \le 300 \ \mu\text{s}; \ \delta \le 0.01$                | 50   | 60   | 70   | V    |
| I <sub>DSS</sub>     | Drain source leakage current  | $V_{DS} = 40 V$  | -    | -    | 100  | μA   |
|                      |                               | $T_{mb} = 25^{\circ}C$   | -    | 0.1  | 10   | μA   |
|                      | On-state                      | $V_{\text{IS}} \geq 4.4~\text{V};~t_{\text{p}} \leq 300~\mu\text{s};~\delta \leq 0.01$ |      |      |      |      |
| R <sub>DS(ON)</sub>  | Drain-source resistance       | I <sub>DM</sub> = 10 A   | -    | -    | 52   | mΩ   |
|                      |                               | $T_{mb} = 25^{\circ}C$   | -    | 22   | 28   | mΩ   |

#### **OVERLOAD CHARACTERISTICS**

 $V_{\text{IS}}$  = 5 V;  $T_{\text{mb}}$  = 25°C unless otherwise specified.

| SYMBOL           | PARAMETER                                   | CONDITIONS   | MIN. | TYP. | MAX. | UNIT |
|------------------|---|--|------|------|------|------|
|                  | Short circuit load                          |  |      |      |      |      |
| I <sub>D</sub>   | Drain current limiting                      | V <sub>DS</sub> = 13 V   | 28.5 | 43   | 57   | А    |
|                  |   | $4.4 V \le V_{IS} \le 5.5 V;$<br>-40°C ≤ T <sub>mb</sub> ≤ 150°C | 21   | -    | 65   | A    |
|                  | Overload protection                         |  |      |      |      |      |
| $P_{D(TO)}$      | Overload power threshold                    | device trips if $P_D > P_{D(TO)}$                                | 75   | 185  | 250  | W    |
| T <sub>DSC</sub> | Characteristic time                         | which determines trip time <sup>1</sup>                          | 200  | 380  | 600  | μs   |
|                  | Overtemperature protection                  |  |      |      |      |      |
| $T_{j(TO)}$      | Threshold junction temperature <sup>2</sup> |  | 150  | 170  | -    | °C   |

<sup>1</sup> Trip time  $t_{d \, sc}$  varies with overload dissipation  $P_D$  according to the formula  $t_{d \, sc} \approx T_{DSC} / \ln[P_D / P_{D(TO)}]$ .

 $<sup>\</sup>boldsymbol{2}$  This is independent of the dV/dt of input voltage  $V_{\text{IS}}.$ 

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#### **INPUT CHARACTERISTICS**

The supply for the logic and overload protection is taken from the input. Limits are for -40°C  $\leq T_{mb} \leq 150$ °C; typicals are for  $T_{mb} = 25$ °C unless otherwise specified

| SYMBOL              | PARAMETER   | CONDITIONS                       |  | MIN.       | TYP.       | MAX.       | UNIT     |
|---------------------|---|----------------------------------|--|------------|------------|------------|----------|
| V <sub>IS(TO)</sub> | Input threshold voltage   | $V_{DS} = 5 V; I_{D} = 1 mA$     | T <sub>mb</sub> = 25°C                         | 0.6<br>1.1 | -<br>1.6   | 2.4<br>2.1 | V<br>V   |
| I <sub>IS</sub>     | Input supply current  | normal operation;                | V <sub>IS</sub> = 5 V<br>V <sub>IS</sub> = 4 V | 100<br>80  | 220<br>195 | 400<br>330 | μΑ<br>μΑ |
| I <sub>ISL</sub>    | Input supply current  | protection latched;              | V <sub>IS</sub> = 5 V<br>V <sub>IS</sub> = 3 V | 200<br>130 | 400<br>250 | 650<br>430 | μΑ<br>μΑ |
| V <sub>ISR</sub>    | Protection reset voltage <sup>1</sup>                           | reset time $t_r \ge 100 \ \mu s$ |  | 1.5        | 2          | 2.9        | V        |
| t <sub>ır</sub>     | Latch reset time  | $V_{IS1} = 5 V, V_{IS2} < 1 V$   |  | 10         | 40         | 100        | μs       |
| V <sub>(CL)IS</sub> | Input clamping voltage  | l <sub>i</sub> = 1.5 mA          |  | 5.5        | -          | 8.5        | V        |
| R <sub>IG</sub>     | Input series resistance <sup>2</sup><br>to gate of power MOSFET |                                  | $T_{mb} = 25^{\circ}C$                         | -          | 33         | -          | kΩ       |

#### SWITCHING CHARACTERISTICS

 $T_{mb}$  = 25°C;  $V_{DD}$  = 13 V; resistive load  $R_L$  = 4  $\Omega$ . Refer to waveform figure and test circuit.

| SYMBOL             | PARAMETER           | CONDITIONS     | MIN. | TYP. | MAX. | UNIT |
|--------------------|---------------------|----------------|------|------|------|------|
| t <sub>d on</sub>  | Turn-on delay time  | $V_{IS} = 5 V$ | -    | 25   | 50   | μs   |
| t,                 | Rise time           |                | -    | 50   | 100  | μs   |
| t <sub>d off</sub> | Turn-off delay time | $V_{IS} = 0 V$ | -    | 60   | 120  | μs   |
| t <sub>r</sub>     | Fall time           |                | -    | 50   | 100  | μs   |

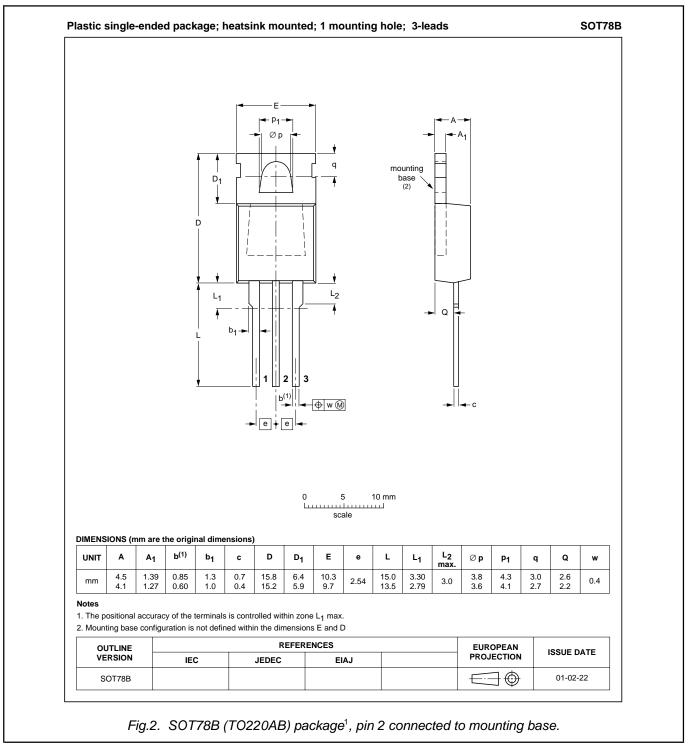
<sup>1</sup> The input voltage below which the overload protection circuits will be reset.

<sup>2</sup> Not directly measureable from device terminals.

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#### **MECHANICAL DATA**



<sup>1</sup> Refer to mounting instructions for SOT78 (TO220) envelopes. Epoxy meets UL94 V0 at 1/8". Net mass: 2 g

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#### DEFINITIONS

| DATA SHEET STA                    | TUS                            |   |
|-----------------------------------|--------------------------------|---|
| DATA SHEET<br>STATUS <sup>1</sup> | PRODUCT<br>STATUS <sup>2</sup> | DEFINITIONS   |
| Objective data                    | Development                    | This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice  |
| Preliminary data                  | Qualification                  | This data sheet contains data from the preliminary specification.<br>Supplementary data will be published at a later date. Philips<br>Semiconductors reserves the right to change the specification without<br>notice, in ordere to improve the design and supply the best possible<br>product                                    |
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| Limiting values                   | •                              | ·   |

Limiting values are given in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of this specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

#### **Application information**

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